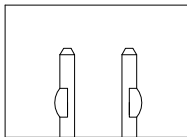
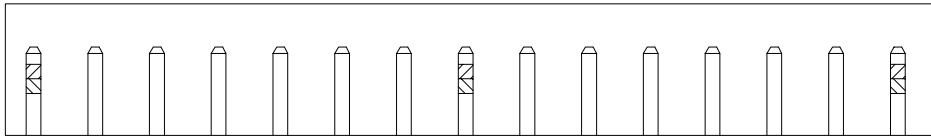
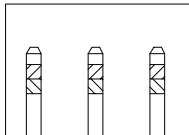
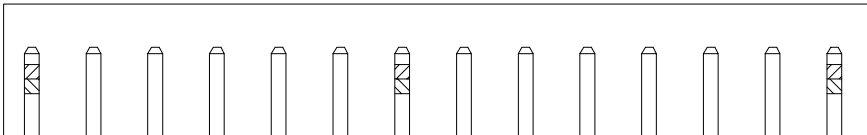
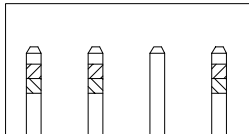
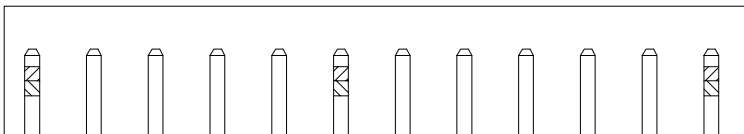
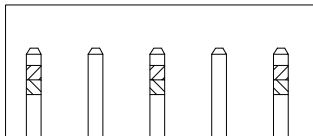
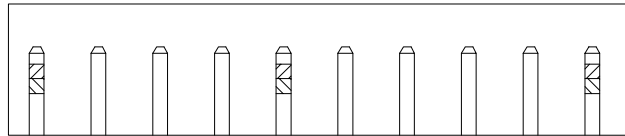
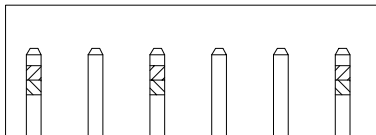
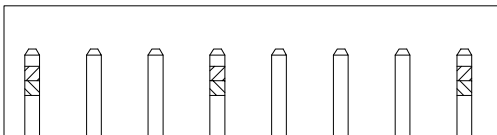


	1	2	3	4	5	6	7	8					
The product using material and processing must conform to the "WI-PZ-001"HSF technical standard control requirements													
A	RoHS			PIN位打K示意图									
B													
C	2P			15P									
D													
E	3P			13P~14P									
F													
G	4P			11P~12P									
H													
	5P			9P~10P									
													
	6P			7P~8P									
H	REV.	REVISION RECORD	DATE		GENERAL TOLERANCES		SCALE: 1:1	NAME	DATE	PART.NO:	DWG.NO:	 WanLian Technology Co., Ltd	
	A0	NEW RELEASE	22.10.28		LINEAR	ANGLES	APPROVED	Wang_jr	23.09.12	A2508W02-1XX1XX2			
	A1	PART NUMBER RENEWAL	23.09.12		0.0±0.35	X°REF±6°	DESIGNER	Han_Gao	23.09.12	TITLE: Pitch 2.50mm XA 单排 Wafer 打K 带柱			
					UNIT:mm	0.00±0.25	X°±3°						
					SIZE: A4	0.000±0.10	X°X' ±2°	DRAWN	LanXuan_Hou	23.09.12			
	1	2	3	4	5	6	7	8					